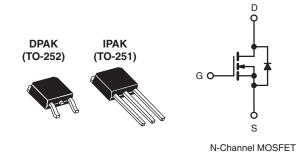


Vishay Siliconix

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V	0.10			
Q _g (Max.) (nC)	25				
Q _{gs} (nC)	5.8	3			
Q _{gd} (nC)	11				
Configuration	Single				



FEATURES

- · Dynamic dV/dt Rating
- Surface Mount (IRFR020/SiHFR020)
- · Available in Tape and Reel
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- · Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques.

ORDERING INFORMATION				
Package	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Load (Ph) from	IRFR020PbF	IRFR020TRPbFa	IRFU020PbF	
Lead (Pb)-free	SiHFR020-E3	SiHFR020T-E3a	SiHFU020-E3	
SnPb	IRFR020	IRFR020TR ^a	IRFU020	
SHPD	SiHFR020	SiHFR020T ^a	SiHFU020	

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	60	V	
Gate-Source Voltage			V_{GS}	± 20	\ \ \	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	14	А	
Continuous Drain Current		T _C = 100 °C		9.0		
Pulsed Drain Current ^a			I _{DM}	56		
Linear Derating Factor				0.33	W/°C	
Linear Derating Factor (PCB Mount)e				0.020	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Single Pulse Avalanche Energy ^b			E _{AS}	91	mJ	
Maximum Power Dissipation	T _C =	T _C = 25 °C		42	W	
Maximum Power Dissipation (PCB Mount) ^e	T _A = 25 °C		P _D	2.5	VV	
Peak Diode Recovery dV/dtc			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature)	for	10 s	_	260 ^d		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD}=25$ V, starting $T_J=25$ °C, L=541 μH , $R_G=25$ Ω , $I_{AS}=14$ A (see fig. 12). c. $I_{SD}\leq 17$ A, $dI/dt\leq 110$ A/ μs , $V_{DD}\leq V_{DS}$, $T_J\leq 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFR020, IRFU020, SiHFR020, SiHFU020

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	-	110	
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				•		•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.073	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	٧
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zava Cata Valtaria Brain Comment		V _{DS} = 60 V, V _{GS} = 0 V		-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V	V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8.4 A ^b	-	-	0.10	Ω
Forward Transconductance	9 _{fs}	V _{DS} :	= 25 V, I _D = 8.4 A	6.2	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	640	-	
Output Capacitance	C _{oss}			-	360	-	pF
Reverse Transfer Capacitance	C _{rss}			-	79	-	
Total Gate Charge	Qg			-	-	25	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b		-	5.8	nC
Gate-Drain Charge	Q _{gd}		see lig. 6 and 13	-	-	11	1
Turn-On Delay Time	t _{d(on)}	$V_{DD}=30~\text{V, I}_D=17~\text{A,}$ $R_G=18~\Omega,~R_D=1.7~\Omega,~\text{see fig. }10^b$		-	13	-	- ns
Rise Time	t _r			-	58	-	
Turn-Off Delay Time	t _{d(off)}			-	25	-	
Fall Time	t _f			-	42	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact ^c		-	4.5	-	الم
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym	MOSFET symbol showing the		-	14	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	56	
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 14 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 17 A, dl/dt = 100 A/μs ^b		-	88	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.29	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and I				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

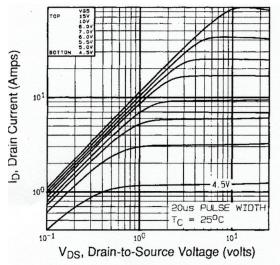
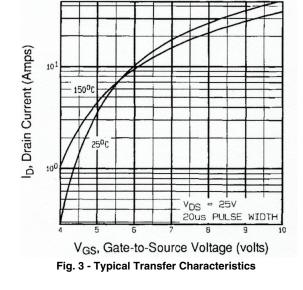


Fig. 1 - Typical Output Characteristics, T_C = 25 °C



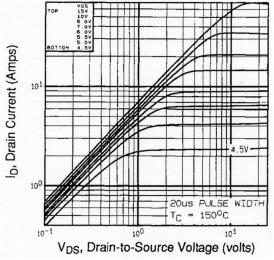


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

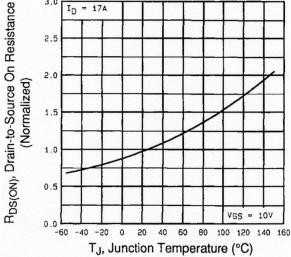


Fig. 4 - Normalized On-Resistance vs. Temperature

IRFR020, IRFU020, SiHFR020, SiHFU020

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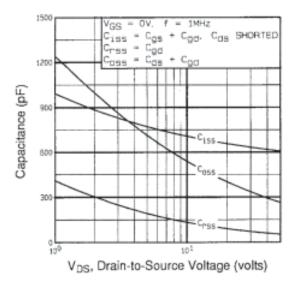


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

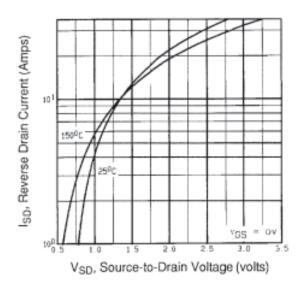


Fig. 7 - Typical Source-Drain Diode Forward Voltage

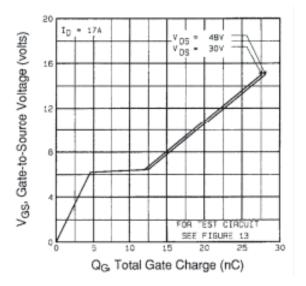


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

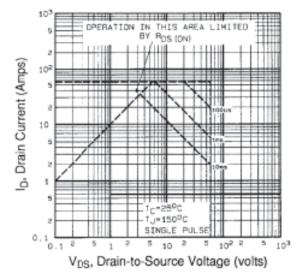


Fig. 8 - Maximum Safe Operating Area





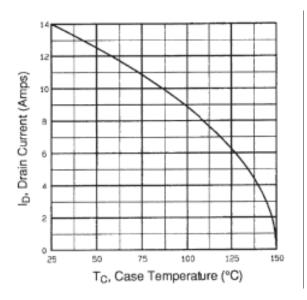


Fig. 9 - Maximum Drain Current vs. Case Temperature

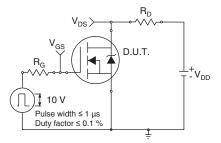


Fig. 10a - Switching Time Test Circuit

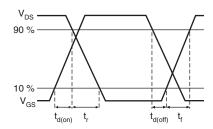


Fig. 10b - Switching Time Waveforms

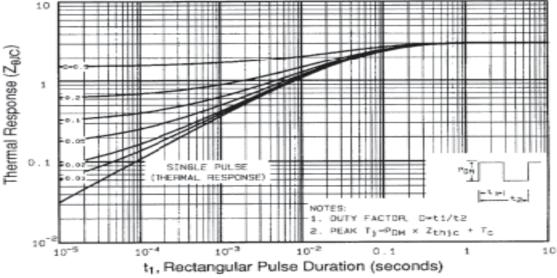


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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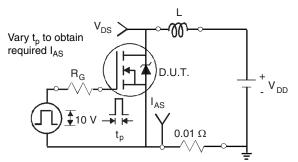


Fig. 12a - Unclamped Inductive Test Circuit

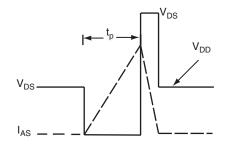


Fig. 12b - Unclamped Inductive Waveforms

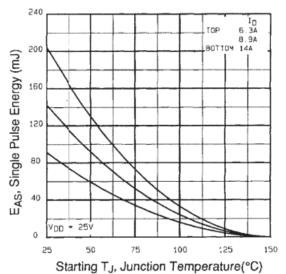


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

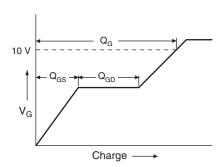


Fig. 13a - Basic Gate Charge Waveform

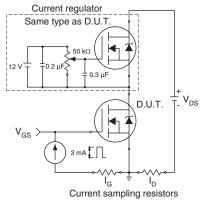
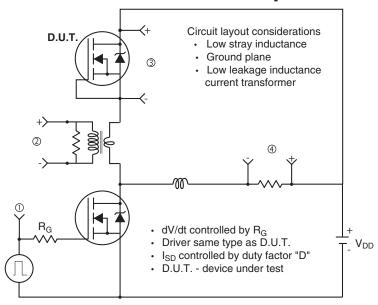


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



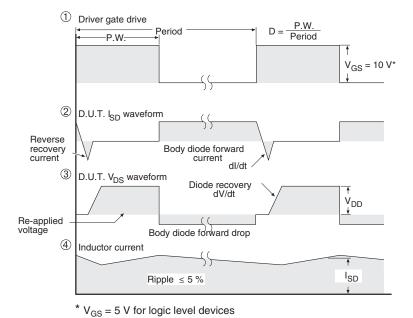


Fig. 14 - For N-Channel

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